# **STU6N90K5**



# N-channel 900 V, 0.91 Ω typ., 6 A MDmesh™ K5 Power MOSFET in an IPAK package

Datasheet - production data

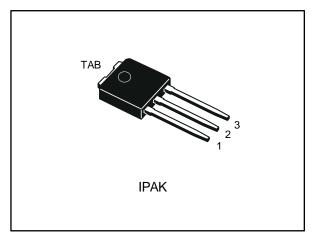
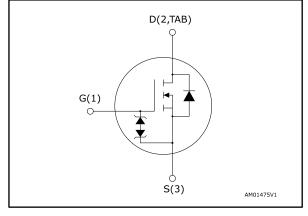


Figure 1: Internal schematic diagram



### **Features**

| Order code | V <sub>DS</sub> | R <sub>DS(on)</sub> max. | I <sub>D</sub> |  |
|------------|-----------------|--------------------------|----------------|--|
| STU6N90K5  | 900 V           | 1.10 Ω                   | 6 A            |  |

- Industry's lowest R<sub>DS(on)</sub> x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### **Description**

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

**Table 1: Device summary** 

| Order code | Marking | Package | Packing |
|------------|---------|---------|---------|
| STU6N90K5  | 6N90K5  | IPAK    | Tube    |

Contents STU6N90K5

# **Contents**

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STU6N90K5 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol                        | Parameter   | Value       | Unit |  |
|-------------------------------|---|-------------|------|--|
| V <sub>G</sub> s              | Gate-source voltage                                   | ± 30        | V    |  |
| I <sub>D</sub>                | Drain current (continuous) at T <sub>C</sub> = 25 °C  | 6           | Α    |  |
| ΙD                            | Drain current (continuous) at T <sub>C</sub> = 100 °C | 4           | Α    |  |
| I <sub>D</sub> <sup>(1)</sup> | Drain current (pulsed)                                | 24          | Α    |  |
| P <sub>TOT</sub>              | Total dissipation at T <sub>C</sub> = 25 °C           | 110 W       |      |  |
| dv/dt (2)                     | Peak diode recovery voltage slope                     | 4.5         | V/ns |  |
| dv/dt (3)                     | MOSFET dv/dt ruggedness                               | ess 50      |      |  |
| Tj                            | Operating junction temperature range                  | - 55 to 150 |      |  |
| T <sub>stg</sub>              | Storage temperature range                             | - 55 to 150 |      |  |

#### Notes:

Table 3: Thermal data

| Symbol                | Parameter                           | Value | Unit |
|-----------------------|-------------------------------------|-------|------|
| R <sub>thj-case</sub> | Thermal resistance junction-case    | 1.14  | °C/W |
| R <sub>thj-amb</sub>  | Thermal resistance junction-ambient | 100   | °C/W |

**Table 4: Avalanche characteristics** 

| Symbol          | Parameter  | Value | Unit |
|-----------------|--|-------|------|
| I <sub>AR</sub> | Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )       | 2     | А    |
| Eas             | Single pulse avalanche energy (starting $T_j$ = 25 °C, $I_D$ = $I_{AR}$ , $V_{DD}$ = 50 V) | 210   | mJ   |

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area

 $<sup>^{(2)}</sup>I_{SD} \le 6$  A, di/dt  $\le 100$  A/µs; VDs peak < V(BR)DSS, VDD = 450 V.

 $<sup>^{(3)}</sup>V_{DS} \le 720 \text{ V}$ 

Electrical characteristics STU6N90K5

### 2 Electrical characteristics

T<sub>C</sub> = 25 °C unless otherwise specified

Table 5: On/off-state

| Symbol               | Parameter  | Test conditions  | Min. | Тур. | Max. | Unit |
|----------------------|--|--|------|------|------|------|
| V <sub>(BR)DSS</sub> | Drain-source breakdown voltage                   | $V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$                                       | 900  |      |      | V    |
|                      | Zava mata walta na duain                         | $V_{GS} = 0 \text{ V}, V_{DS} = 900 \text{ V}$                                   |      |      | 1    | μΑ   |
| I <sub>DSS</sub>     | I <sub>DSS</sub> Zero gate voltage drain current | $V_{GS} = 0 \text{ V}, V_{DS} = 900 \text{ V}$<br>$T_{C} = 125 \text{ °C}^{(1)}$ |      |      | 50   | μΑ   |
| Igss                 | Gate body leakage current                        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$                                |      |      | ±10  | μΑ   |
| V <sub>GS(th)</sub>  | Gate threshold voltage                           | $V_{DD} = V_{GS}$ , $I_D = 100 \mu A$  | 3    | 4    | 5    | V    |
| R <sub>DS(on)</sub>  | Static drain-source on-<br>resistance            | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A                                     |      | 0.91 | 1.10 | Ω    |

#### Notes:

**Table 6: Dynamic** 

| Symbol                            | Parameter                             | Test conditions  | Min. | Тур. | Max. | Unit |
|-----------------------------------|---------------------------------------|--|------|------|------|------|
| Ciss                              | Input capacitance                     |  | -    | 342  | -    | pF   |
| Coss                              | Output capacitance                    | $V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$<br>$V_{GS} = 0 \text{ V}$ | -    | 31   | -    | pF   |
| $C_{rss}$                         | Reverse transfer capacitance          | VG3 - V V  | -    | 1.2  | -    | pF   |
| C <sub>o(tr)</sub> (1)            | Equivalent capacitance time related   | V <sub>DS</sub> = 0 to 720 V,  | -    | 55   | -    | pF   |
| C <sub>o(er)</sub> <sup>(2)</sup> | Equivalent capacitance energy related | V <sub>G</sub> S = 0 V   | -    | 20   | -    | pF   |
| Rg                                | Intrinsic gate resistance             | f = 1 MHz, I <sub>D</sub> = 0 A  | -    | 6.4  | -    | Ω    |
| $Q_g$                             | Total gate charge                     | $V_{DD} = 720 \text{ V}, I_D = 6 \text{ A}$                            | -    | 11   | -    | nC   |
| Qgs                               | Gate-source charge                    | V <sub>GS</sub> = 10 V   | -    | 2.5  | -    | nC   |
| $Q_gd$                            | Gate-drain charge                     | (see Figure 15: "Test circuit<br>for gate charge behavior")            | -    | 7    | -    | nC   |

#### Notes

<sup>&</sup>lt;sup>(1)</sup> Defined by design, not subject to production test.

 $<sup>^{(1)}</sup>$  C<sub>o(tr)</sub> is a constant capacitance value that gives the same charging time as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 to 80% V<sub>DSS</sub>.

 $<sup>^{(2)}</sup>$  C<sub>o(er)</sub> is a constant capacitance value that gives the same stored energy as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 to 80% V<sub>DSS</sub>

Table 7: Switching times

| Symbol              | Parameter           | Test conditions   | Min. | Тур. | Max. | Unit |
|---------------------|---------------------|---|------|------|------|------|
| t <sub>d(on)</sub>  | Turn-on delay time  | $V_{DD}$ = 450 V, $I_D$ = 3 A,  | -    | 12.4 | •    | ns   |
| tr                  | Rise time           | $R_G = 4.7 \Omega$  | -    | 12.2 | •    | ns   |
| t <sub>d(off)</sub> | Turn-off delay time | V <sub>GS</sub> = 10 V<br>(see Figure 14: "Test circuit for                     | -    | 30.4 | -    | ns   |
| t <sub>f</sub>      | Fall time           | resistive load switching times"<br>and Figure 19: "Switching time<br>waveform") | -    | 15.5 | -    | ns   |

#### Table 8: Source-drain diode

| Symbol                          | Parameter                     | Test conditions  | Min. | Тур. | Max. | Unit |
|---------------------------------|-------------------------------|--|------|------|------|------|
| I <sub>SD</sub>                 | Source-drain current          |  | -    |      | 6    | Α    |
| I <sub>SDM</sub> <sup>(1)</sup> | Source-drain current (pulsed) |  | 1    |      | 24   | А    |
| V <sub>SD</sub> <sup>(2)</sup>  | Forward on voltage            | I <sub>SD</sub> = 6 A, V <sub>GS</sub> = 0 V   | -    |      | 1.5  | V    |
| t <sub>rr</sub>                 | Reverse recovery time         | $I_{SD} = 6 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$   | -    | 342  |      | ns   |
| Qrr                             | Reverrse recovery charge      | V <sub>DD</sub> = 60 V<br>(see Figure 16: "Test circuit for<br>inductive load switching and<br>diode recovery times")                          | -    | 3.13 |      | μC   |
| I <sub>RRM</sub>                | Reverse recovery current      |  | -    | 18.3 |      | А    |
| t <sub>rr</sub>                 | Reverse recovery time         | $I_{SD} = 6 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$   | -    | 536  |      | ns   |
| Qrr                             | Reverse recovery charge       | V <sub>DD</sub> = 60 V, T <sub>j</sub> = 150 °C<br>(see Figure 16: "Test circuit for<br>inductive load switching and<br>diode recovery times") | -    | 4.42 |      | μC   |
| I <sub>RRM</sub>                | Reverse recovery current      |  | -    | 16.5 |      | А    |

### Notes:

Table 9: Gate-source Zener diode

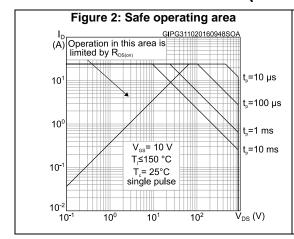
| Symbol        | Parameter                     | Test conditions                                | Min. | Тур. | Max. | Unit |
|---------------|-------------------------------|--|------|------|------|------|
| $V_{(BR)GSO}$ | Gate-source breakdown voltage | $I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$ | 30   | -    | 1    | V    |

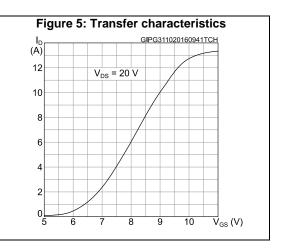
The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

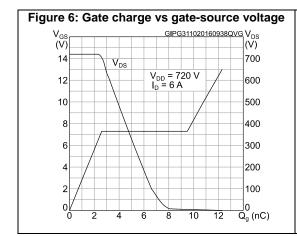
<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area

 $<sup>^{(2)}</sup>$ Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

# 2.1 Electrical characteristics (curves)







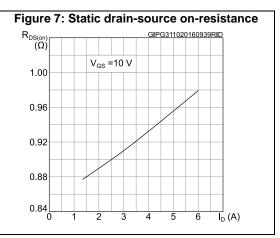


Figure 8: Capacitance variations

C GIPG311020160937CVR

10<sup>3</sup>

10<sup>2</sup>

Coss

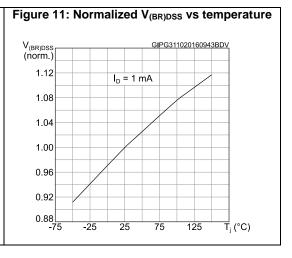
C

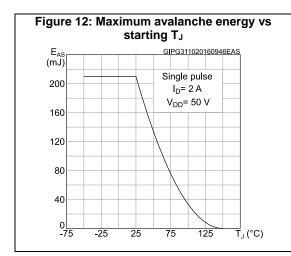
Figure 10: Normalized on-resistance vs temperature

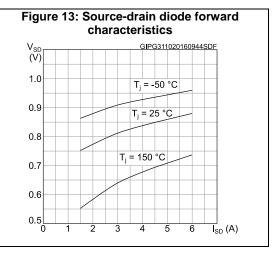
R<sub>DS(on)</sub> GIPG311020160944RON

2.6 V<sub>GS</sub> = 10 V

2.2 1.8 1.4 1.0 0.6 0.2 0.2 -75 -25 25 75 125 T<sub>j</sub> (°C)







Test circuits STU6N90K5

## 3 Test circuits

Figure 14: Test circuit for resistive load switching times

Figure 15: Test circuit for gate charge behavior

Figure 15: Test circuit for gate charge behavior

OVDD

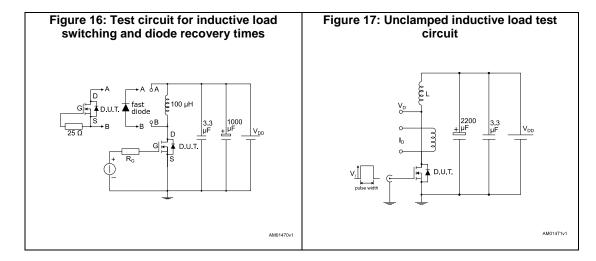
RL

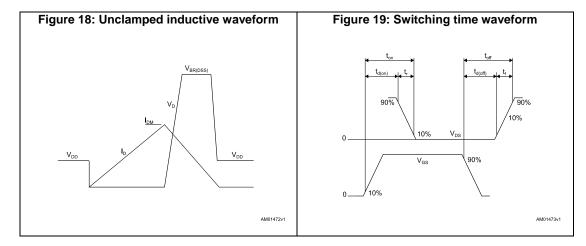
Vos

pulse width

AM01468v1

AM01468v1





STU6N90K5 Package information

## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

## 4.1 IPAK (TO-251) type C package information

D2 (x3)

b2 (x3)

b (x3)

c2 A

EE1

O068771\_IK\_typeC\_rev14

Figure 20: IPAK (TO-251) type C package outline

Table 10: IPAK (TO-251) type C package mechanical data

| Table 10: IFAK (10-251) type C package mechanical data |       |       |       |  |  |  |
|--|-------|-------|-------|--|--|--|
| Dim.   |       | mm    |       |  |  |  |
| Dilli.   | Min.  | Тур.  | Max.  |  |  |  |
| А  | 2.20  | 2.30  | 2.35  |  |  |  |
| A1   | 0.90  | 1.00  | 1.10  |  |  |  |
| b  | 0.66  |       | 0.79  |  |  |  |
| b2   |       |       | 0.90  |  |  |  |
| b4   | 5.23  | 5.33  | 5.43  |  |  |  |
| С  | 0.46  |       | 0.59  |  |  |  |
| c2   | 0.46  |       | 0.59  |  |  |  |
| D  | 6.00  | 6.10  | 6.20  |  |  |  |
| D1   | 5.20  | 5.37  | 5.55  |  |  |  |
| Е  | 6.50  | 6.60  | 6.70  |  |  |  |
| E1   | 4.60  | 4.78  | 4.95  |  |  |  |
| е  | 2.20  | 2.25  | 2.30  |  |  |  |
| e1   | 4.40  | 4.50  | 4.60  |  |  |  |
| Н  | 16.18 | 16.48 | 16.78 |  |  |  |
| L  | 9.00  | 9.30  | 9.60  |  |  |  |
| L1   | 0.90  | 1.00  | 1.20  |  |  |  |
| L2   | 0.90  | 1.08  | 1.25  |  |  |  |
| θ1   | 3°    | 5°    | 7°    |  |  |  |
| θ2   | 1°    | 3°    | 5°    |  |  |  |

STU6N90K5 Revision history

# 5 Revision history

**Table 11: Document revision history** 

| Date        | Revision | Changes        |
|-------------|----------|----------------|
| 02-Nov-2016 | 1        | First release. |

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